504432030 06/27/2017

PATENT ASSIGNMENT COVER SHEET

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CONVEYING PARTY DATA

Name	Execution Date
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TORU MASUDA	06/12/2017
HIROSHI KAGEYAMA	06/12/2017
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RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15529427

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NAME OF SUBMITTER:	MICHAEL H. JACOBS
SIGNATURE:	/Michael H. Jacobs/
DATE SIGNED:	06/27/2017

Total Attachments: 2

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> PATENT **REEL: 042821 FRAME: 0339** 504432030

As a below named inventor, I hereby declare that:

[N CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me, citizen of Japan,

by Hitachi, Ltd., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo 100-8280, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd.,

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ACOUSTIC EMISSION WAVE DETECTOR, ACOUSTIC EMISSION WAVE DETECTION SYSTEM, AND ACOUSTIC EMISSION WAVE DETECTION METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to Issue said Letters Patent to said Hitachi, Ltd..

Signed on the date(s) indicated aside signatures:

INVENTOR(S)
(発明者ウルネームサイン)

Date Signed (署名目)

1) Paichi Kawamura
Daichi Kawamura

Daichi Kawamura

June 12, 2017

Toru Masuda

June 12, 2017

PATENT REEL: 042821 FRAME: 0340 INVENTOR(S) (発明者フルネームサイン) Date Signed (署名日)

3) Hiroshi Kegeyana

June 12, 2017.

4) Cymu Hatanaba

June 15, 2017

PATENT REEL: 042821 FRAME: 0341

RECORDED: 06/27/2017